SN54LS373, SN54LS374, SN54S373, SN54S374, SN74LS373, SN74LS374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

SDLS165B - OCTOBER 1975 - REVISED AUGUST 2002

- Choice of Eight Latches or Eight D-Type Flip-Flops in a Single Package
- 3-State Bus-Driving Outputs
- Full Parallel Access for Loading
- Buffered Control Inputs
- Clock-Enable Input Has Hysteresis to Improve Noise Rejection ('S373 and 'S374)
- P-N-P Inputs Reduce DC Loading on Data Lines ('S373 and 'S374)

description

These 8-bit registers feature 3-state outputs designed specifically for driving highly capacitive relatively low-impedance loads. high-impedance 3-state and increased high-logic-level drive provide these registers with the capability of being connected directly to and driving the bus lines in a bus-organized system without need for interface or pullup components. These devices are particularly attractive for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight latches of the 'LS373 and 'S373 are transparent D-type latches, meaning that while the enable (C or CLK) input is high, the Q outputs follow the data (D) inputs. When C or CLK is taken low, the output is latched at the level of the data that was set up.

The eight flip-flops of the 'LS374 and 'S374 are edge-triggered D-type flip-flops. On the positive transition of the clock, the Q outputs are set to the logic states that were set up at the D inputs.

SN54LS373, SN54LS374, SN54S373, SN54S374...J OR W PACKAGE SN74LS373, SN74S374...DW, N, OR NS PACKAGE SN74LS374...DB, DW, N, OR NS PACKAGE SN74S373...DW OR N PACKAGE (TOP VIEW)

The state of the s		$\overline{}$		1
OC [1	O	20] ∨ _{cc}
1Q [2		19	[] 8Q
1D [3		18] 8D
2D [4		17] 7D
2Q [5		16] 7Q
3Q [6		15] 6Q
3D [7		14] 6D
4D [8		13] 5D
4Q [9		12] 5Q
GND [10		11] C†

† C for 'LS373 and 'S373; CLK for 'LS374 and 'S374.

SN54LS373, SN54LS374, SN54S373, SN54S374 . . . FK PACKAGE (TOP VIEW)



† C for 'LS373 and 'S373; CLK for 'LS374 and 'S374.

Schmitt-trigger buffered inputs at the enable/clock lines of the 'S373 and 'S374 devices simplify system design as ac and dc noise rejection is improved by typically 400 mV due to the input hysteresis. A buffered output-control (\overline{OC}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly.

OC does not affect the internal operation of the latches or flip-flops. That is, the old data can be retained or new data can be entered, even while the outputs are off.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



ORDERING INFORMATION

TA	PACI	KAGE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
		Tube	SN74LS373N	SN74LS373N
	PDIP – N	Tube	SN74LS374N	SN74LS374N
	PDIP = N	Tube	SN74S373N	SN74S373N
		Tube	SN74S374N	SN74S374N
		Tube	SN74LS373DW	LS373
		Tape and reel	SN74LS373DWR	L33/3
		Tube	SN74LS374DW	1.0074
000 to 7000	SOIC - DW	Tape and reel	SN74LS374DWR	LS374
0°C to 70°C	SOIC - DW	Tube	SN74S373DW	0070
		Tape and reel	SN74S373DWR	S373
		Tube	SN74S374DW	0074
		Tape and reel	SN74S374DWR	S374
		Tape and reel	SN74LS373NSR	74LS373
	SOP - NS	Tape and reel	SN74LS374NSR	74LS374
		Tape and reel	SN74S374NSR	74S374
	SSOP - DB	Tape and reel	SN74LS374DBR	LS374A
		Tube	SN54LS373J	SN54LS373J
		Tube	SNJ54LS373J	SNJ54LS373J
		Tube	SN54LS374J	SN54LS374J
	CDIP – J	Tube	SNJ54LS374J	SNJ54LS374J
	CDIP - J	Tube	SN54S373J	SN54S373J
		Tube	SNJ54S373J	SNJ54S373J
		Tube	SN54S374J	SN54S374J
–55°C to 125°C		Tube	SNJ54S374J	SNJ54S374J
		Tube	SNJ54LS373W	SNJ54LS373W
	CFP – W	Tube	SNJ54LS374W	SNJ54LS374W
		Tube	SNJ54S374W	SNJ54S374W
		Tube	SNJ54LS373FK	SNJ54LS373FK
	LCCC – FK	Tube	SNJ54LS374FK	SNJ54LS374FK
	LCCC - FK	Tube	SNJ54S373FK	SNJ54S373FK
		Tube	SNJ54S374FK	SNJ54S374FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Function Tables

'LS373, 'S373 (each latch)

	INPUTS		OUTPUT
<u>oc</u>	С	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Χ	Q_0
Н	Χ	Χ	z

'LS374, 'S374 (each latch)

	INPUTS		OUTPUT
oc	CLK	D	Q
L	\uparrow	Н	Н
L	\uparrow	L	L
L	L	Χ	Q_0
Н	X	X	Z

logic diagrams (positive logic)

'LS373, 'S373 **Transparent Latches** $\overline{\mathsf{oc}}$ C1 - 1Q 1D -1D C1 1D 2D C1 3Q 1D C1 1D 4D C1 13 1D 5D C1 14 1D 6D C1 17 1D 7D

C1

1D

18

8D





8Q

schematic of inputs and outputs

'LS373



'LS374



SN54LS373, SN54LS374, SN54S373, SN54S374, SN74LS373, SN74LS374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

SDLS165B - OCTOBER 1975 - REVISED AUGUST 2002

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)† ('LS devices)

Supply voltage, V _{CC} (see Note 1)		7 V
Input voltage, V _I		7 V
Off-state output voltage		5.5 V
Package thermal impedance, θ_{JA} (see Note 2):	DB package	70°C/W
***	DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
Storage temperature range, T _{sto}		-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN54LS'			SN74LS'			UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNII	
Vcc	Supply voltage		4.5	5	5	4.75	5	5.25	V	
Vон	High-level output voltage				5.5			5.5	V	
Іон	High-level output current				-1			-2.6	mA	
loL	Low-level output current				12			24	mA	
	Pulse duration	CLK high	15			15			no	
t _W		CLK low	15			15			ns	
	Data setup time	'LS373	5↓			5↓			no	
t _{su}	Data setu p time	'LS374	20↑			20↑			ns	
4.	Data hold time	'LS373	20↓			20↓			ns	
th	Data hold time	'LS374 [‡]	5↑			01				
TA	Operating free-air temperature				125	0		70	°C	

[‡] The th specification applies only for data frequency below 10 MHz. Designs above 10 MHz should use a minimum of 5 ns (commercial only).



NOTES: 1. Voltage values are with respect to network ground terminal.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETED			+	,	SN54LS	,	,	SN74LS	'	
	PARAMETER	TEST	CONDITION	ISI	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			2			V
V _{IL}	Low-level input voltage						0.7			0.8	V
٧ıĸ	Input clamp voltage	V _{CC} = MIN,	l _l = −18 mA				-1.5			-1.5	V
VOH	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = MAX		2.4	3.4		2.4	3.1		٧
V	/	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	V
VOL	Low-level output voltage	V _{IL} = V _{IL} max		I _{OL} = 24 mA					0.35	0.5	V
lozh	Off-state output current, high-level voltage applied	V _{CC} = MAX, V _O = 2.7 V	V _{IH} = 2 V,				20			20	μΑ
lozL	Off-state output current, low-level voltage applied	$V_{CC} = MAX,$ $V_{O} = 0.4 V$	V _{IH} = 2 V,				-20			-20	μΑ
ΙΙ	Input current at maximum input voltage	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
lн	High-level input current	$V_{CC} = MAX$,	V _I = 2.7 V				20			20	μΑ
Ι _Ι L	Low-level input current	$V_{CC} = MAX$,	V _I = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current§	$V_{CC} = MAX$			-30		-130	-30		-130	mA
la a	Cumply ourrant	V _{CC} = MAX,		'LS373		24	40		24	40	mA
Icc	Supply current	Output control a	t 4.5 V	'LS374		27	40		27	40	IIIA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see Figure 1)

PARAMETER	FROM	то	TEST CONDITIONS	'LS373			'LS374			UNIT
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
f _{max}			$R_L = 667 \Omega$, $C_L = 45 pF$, See Note 3				35	50		MHz
t _{PLH}	Data	Any Q	$R_L = 667 \Omega, C_L = 45 pF,$		12	18				no
tPHL	Dala	Arry Q	See Note 3		12	18				ns
tPLH	C or CLK	Any Q	$R_L = 667 \Omega$, $C_L = 45 pF$, See Note 3		20	30		15	28	no
t _{PHL}	C OI CLK	Ally Q			18	30		19	28	ns
^t PZH	oc	Any Q	$R_L = 667 \Omega, C_L = 45 pF,$		15	28		20	26	ns
t _{PZL}	00	Arry Q	See Note 3		25	36		21	28	110
^t PHZ	oc	Any Q	$R_1 = 667 \Omega, C_1 = 5 pF$		15	25		15	28	ns
t _{PLZ}	5	Ally Q	KL = 007 32, CL = 5 pr		12	20		12	20	115

NOTE 3: Maximum clock frequency is tested with all outputs loaded.

fmax = maximum clock frequency

tplH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

tpzH = output enable time to high level

tpzL = output enable time to low level

tPHZ = output disable time from high level

t_{PLZ} = output disable time from low level



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

SDLS165B - OCTOBER 1975 - REVISED AUGUST 2002

schematic of inputs and outputs

'S373 and 'S374

'S373 and 'S374



SN54LS373, SN54LS374, SN54S373, SN54S374, SN74LS373, SN74LS373, SN74LS374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

SDLS165B - OCTOBER 1975 - REVISED AUGUST 2002

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)† ('S devices)

Supply voltage, V _{CC} (see Note 1)		7 V
Input voltage, V _I		5.5 V
Off-state output voltage		5.5 V
Package thermal impedance, θ _{JA} (see Note 2)	: DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
Storage temperature range, T _{sto}		-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to network ground terminal.

recommended operating conditions

				SN54S'			SN74S'		UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNII	
V _{CC} Supply voltage			4.5	5	5.5	4.75	5	5.25	V	
Vон	High-level output voltage				5.5			5.5	V	
loh	High-level output current				-2			-6.5	mA	
	Pulse duration, clock/enable	High	6			6			ns	
t _W	ruise duration, clock/enable	Low	7.3			7.3			115	
	Data actus timo	'S373	0↓			0↓	-		20	
t _{su}	Data setup time	'S374	5↑			5↑			ns	
4.	Data hold time	'S373	10↓			10↓			no	
^t h	Data Holu time	'S374	2↑			2↑			ns	
TA	Operating free-air temperature		-55		125	0		70	°C	



^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (SN54S373, SN54S374, SN74S373, SN74S374)

PARA	METER		TES	ST CONDITIONS†		MIN	TYP‡	MAX	UNIT
٧ıH						2			V
V _{IL}								0.8	V
٧ıK		$V_{CC} = MIN,$	$I_{I} = -18 \text{ mA}$					-1.2	V
Va	SN54S'	Voo – MIN	\/ 2 \/	V: 0.8 V	lou - MAY	2.4	3.4		V
VOH	SN74S'	$V_{CC} = MIN,$	$V_{IH} = 2 V$	$V_{IL} = 0.8 V$	I _{OH} = MAX	2.4	3.1		V
V_{OL}		$V_{CC} = MIN,$	V _{IH} = 2 V,	$V_{IL} = 0.8 V$,	$I_{OL} = 20 \text{ mA}$			0.5	V
lozh		$V_{CC} = MAX$,	V _{IH} = 2 V,	V _O = 2.4 V				50	μΑ
lozL		$V_{CC} = MAX$,	V _{IH} = 2 V,	$V_0 = 0.5 V$				-50	μΑ
II		$V_{CC} = MAX$,	V _I = 5.5 V					1	mA
lιΗ		$V_{CC} = MAX$,	V _I = 2.7 V					50	μΑ
IIL		$V_{CC} = MAX$,	V _I = 0.5 V					-250	μΑ
los§		$V_{CC} = MAX$				-40		-100	mA
				Outputs high				160	
			'S373	Outputs low				160	
				Outputs disable	d			190	
ICC		$V_{CC} = MAX$		Outputs high				110	mA
		,	'S374	Outputs low				140	
			33/4	Outputs disable	d			160	
				CLK and OC at	4 V, D inputs at 0 V			180	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see Figure 2)

PARAMETER	FROM	то	TEST CONDITIONS		'S373		'S374			UNIT
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
f _{max}			$R_L = 280 \Omega$, $C_L = 15 pF$, See Note 3				75	100		MHz
t _{PLH}	Data	Any Q	$R_L = 280 \Omega, C_L = 15 pF,$		7	12				ns
^t PHL	Dala	Ally Q	See Note 3		7	12				115
t _{PLH}	C or CLK	Any O	Any Q $R_L = 280 \Omega$, $C_L = 15 pF$, See Note 3		7	14		8	15	ns
t _{PHL}	COICLK	Ally Q			12	18		11	17	115
^t PZH	oc	Any Q	$R_L = 280 \Omega, C_L = 15 pF,$		8	15		8	15	ns
t _{PZL}	00	Ally Q	See Note 3		11	18		11	18	115
^t PHZ	oc	Any Q	P 200 O C 5 pE		6	9		5	9	ns
^t PLZ	UC	Ally Q	$R_L = 280 \Omega, C_L = 5 pF$		8	12		7	12	115

NOTE 3. Maximum clock frequency is tested with all outputs loaded.

f_{max} = maximum clock frequency

tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

tpzH = output enable time to high level

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpl 7 = output disable time from low level



[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

PARAMETER MEASUREMENT INFORMATION SERIES 54LS/74LS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 - B. All diodes are 1N3064 or equivalent.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
 - E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
 - F. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_{O} \approx 50 \Omega$, $t_{f} \leq 1.5 \text{ ns}$, $t_{f} \leq 2.6 \text{ ns}$.
 - G. The outputs are measured one at a time with one input transition per measurement.
 - H. All parameters and waveforms are not applicable to all devices .

Figure 1. Load Circuits and Voltage Waveforms



OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

SDLS165B - OCTOBER 1975 - REVISED AUGUST 2002

PARAMETER MEASUREMENT INFORMATION **SERIES 54S/74S DEVICES**



- NOTES: A. C_I includes probe and jig capacitance.
 - B. All diodes are 1N3064 or equivalent.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - D. S1 and S2 are closed for tpLH, tpHL, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
 - E. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O \approx 50 \Omega$; t_r and $t_f \leq$ 7 ns for Series 54/74 devices and t_r and $t_f \le 2.5$ ns for Series 54S/74S devices.
 - F. The outputs are measured one at a time with one input transition per measurement.
 - G. All parameters and waveforms are not applicable to all devices .

Figure 2. Load Circuits and Voltage Waveforms



TYPICAL APPLICATION DATA



Expandable 4-Word by 8-Bit General Register File







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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
78011022A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	78011022A SNJ54LS 374FK	Samples
7801102RA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7801102RA SNJ54LS374J	Samples
7801102SA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7801102SA SNJ54LS374W	Samples
JM38510/32502B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502B2A	Samples
JM38510/32502BRA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502BRA	Samples
JM38510/32502BSA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502BSA	Samples
JM38510/32502SRA	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502SRA	Samples
JM38510/32502SSA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502SSA	Samples
JM38510/32503B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32503B2A	Samples
JM38510/32503BRA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32503BRA	Samples
JM38510/32503BSA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32503BSA	Samples
M38510/32502B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502B2A	Samples
M38510/32502BRA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502BRA	Samples
M38510/32502BSA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502BSA	Samples
M38510/32502SRA	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502SRA	Samples
M38510/32502SSA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32502SSA	Samples





29-Jun-2023 www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
M38510/32503B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32503B2A	Samples
M38510/32503BRA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32503BRA	Samples
M38510/32503BSA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 32503BSA	Samples
SN54LS373J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS373J	Samples
SN54LS374J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS374J	Samples
SN54S373J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S373J	Samples
SN54S374J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S374J	Samples
SN74LS373DWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS373	Samples
SN74LS373N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS373N	Samples
SN74LS373NE4	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS373N	Samples
SN74LS373NSR	ACTIVE	SO	NS	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS373	Samples
SN74LS374DBR	ACTIVE	SSOP	DB	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS374A	Samples
SN74LS374DWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS374	Samples
SN74LS374N	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS374N	Samples
SN74LS374NE4	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS374N	Samples
SN74LS374NSR	ACTIVE	SO	NS	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS374	Samples
SN74S373N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S373N	Samples
SN74S374N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S374N	Samples
SNJ54LS373FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 373FK	Samples



www.ti.com 29-Jun-2023

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS373J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS373J	Samples
SNJ54LS373W	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS373W	Samples
SNJ54LS374FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	78011022A SNJ54LS 374FK	Samples
SNJ54LS374J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7801102RA SNJ54LS374J	Samples
SNJ54LS374W	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7801102SA SNJ54LS374W	Samples
SNJ54S373FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S 373FK	Samples
SNJ54S373J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S373J	Samples
SNJ54S374FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S 374FK	Samples
SNJ54S374J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S374J	Samples
SNJ54S374W	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S374W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

PACKAGE OPTION ADDENDUM

www.ti.com 29-Jun-2023

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS373, SN54LS373-SP, SN54LS374, SN54LS373, SN54LS374, SN74LS373, SN74LS373, SN74LS373, SN74LS373, SN74LS374, SN74LS374, SN74LS373, SN74LS374, SN

Catalog: SN74LS373, SN54LS373, SN74LS374, SN74S373, SN74S374

Military: SN54LS373, SN54LS374, SN54S373, SN54S374

Space: SN54LS373-SP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and gualified for use in Space-based application

PACKAGE MATERIALS INFORMATION

www.ti.com 12-May-2023

TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

	-
A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS373DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74LS373NSR	so	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74LS374DBR	SSOP	DB	20	2000	330.0	16.4	8.2	7.5	2.5	12.0	16.0	Q1
SN74LS374DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74LS374NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1



www.ti.com 12-May-2023



*All dimensions are nominal

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS373DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74LS373NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74LS374DBR	SSOP	DB	20	2000	356.0	356.0	35.0
SN74LS374DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74LS374NSR	so	NS	20	2000	356.0	356.0	41.0



www.ti.com 12-May-2023

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
78011022A	FK	LCCC	20	1	506.98	12.06	2030	NA
7801102SA	W	CFP	20	1	506.98	26.16	6220	NA
JM38510/32502B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/32502BSA	W	CFP	20	1	506.98	26.16	6220	NA
JM38510/32502SSA	W	CFP	20	1	506.98	26.16	6220	NA
JM38510/32503B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/32503BSA	W	CFP	20	1	506.98	26.16	6220	NA
M38510/32502B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/32502BSA	W	CFP	20	1	506.98	26.16	6220	NA
M38510/32502SSA	W	CFP	20	1	506.98	26.16	6220	NA
M38510/32503B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/32503BSA	W	CFP	20	1	506.98	26.16	6220	NA
SN74LS373N	N	PDIP	20	20	506	13.97	11230	4.32
SN74LS373NE4	N	PDIP	20	20	506	13.97	11230	4.32
SN74LS374N	N	PDIP	20	20	506	13.97	11230	4.32
SN74LS374NE4	N	PDIP	20	20	506	13.97	11230	4.32
SN74S373N	N	PDIP	20	20	506	13.97	11230	4.32
SN74S374N	N	PDIP	20	20	506	13.97	11230	4.32
SNJ54LS373FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS373W	W	CFP	20	1	506.98	26.16	6220	NA
SNJ54LS374FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS374W	W	CFP	20	1	506.98	26.16	6220	NA
SNJ54S373FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54S374FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54S374W	W	CFP	20	1	506.98	26.16	6220	NA

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



INSTRUMENTS www.ti.com

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.

 D. Index point is provided on cap for terminal identification only.

 E. Falls within Mil—Std 1835 GDFP2—F20





SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-150.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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